AMENDMENTS TO THE CLAIMS

1.-8. (Canceled)

9. (Previously Presented) A method of forming an insulating film between interconnect layers of a semiconductor device comprising the steps of:

providing a liquid coating composition by dissolving a siloxane-based resin in an organic solvent;

coating a silicon wafer with the liquid coating composition to form a coating film thereon; and

heat-curing the coating film,

wherein the siloxane-based resin is prepared by hydrolyzing and polycondensing a first monomer of the formula (1) and a second monomer of the formula (2) in an organic solvent in the presence of an acid or alkaline catalyst and water:

$$\begin{array}{c|c}
R_1 \\
\hline
Si \\
CH_2(CH_2)_mSiX_1X_2X_3
\end{array}$$
(1)

wherein,

 R_1 is H, C_{1-3} alkyl or C_{6-15} aryl;

each of X_1 , X_2 and X_3 , independently, is C_{1-3} alkyl, C_{1-10} alkoxy or halogen, provided that at least one of them is hydrolysable;

Docket No.: 3811-0130P

m is an integer from 0 to 10; and

p is an integer from 3 to 8; and

$$X_{4} - \begin{cases} R_{2} \\ I \\ S_{1} - O \\ I \\ Y_{1} \end{cases} = \begin{cases} R_{2} \\ I \\ S_{1} - O \\ I \\ R_{2} \end{cases} = \begin{cases} R_{2} \\ I \\ S_{1} - X_{4} \\ I \\ Y_{1} \end{cases}$$

$$(2)$$

Docket No.: 3811-0130P

wherein,

 R_2 is H, C_{1-3} alkyl or C_{6-15} aryl;

 X_4 is C_{1-10} alkoxy;

 Y_1 is C_{1-3} alkyl or C_{1-10} alkoxy; and

n is an integer from 0 to 10.

- 10. (Previously Presented) The method according to claim 9, wherein the siloxane-based resin is mixed with a porogen so that a weight ratio of the resin to the porogen is 99:1-30:70.
- 11. (Original) The method according to claim 9, wherein the porogen is selected from the group consisting of cyclodextrin, polycaprolactone, and a derivative thereof.
- 12. (Original) The method according to claim 9, wherein the organic solvent is selected from the group consisting of an aliphatic hydrocarbon solvent, an aromatic hydrocarbon solvent, a ketone-based solvent, an ether-

based solvent, an acetate-based solvent, an alcohol-based solvent, an amide-

based solvent, a silicon-based solvent, and mixtures thereof.

13. (Original) The method according to claim 9, wherein the organic

solvent is 20-99.9wt% of the liquid coating composition.

14. (Original) The method according to claim 9, wherein the liquid

coating composition is applied to the silicon wafer by spin-coating.

15. (Original) The method according to claim 9, wherein the heat-curing

is conducted at a temperature of 150-600°C for 1-150 minutes.

16. (Canceled)

17. (Previously Presented) An interlayer insulating film made from a

siloxane-based resin, wherein micropores are formed throughout the film by

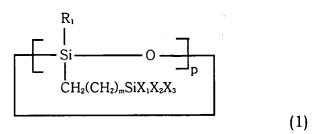
the use of a porogen,

wherein the siloxane-based resin is prepared by hydrolyzing and

polycondensing a first monomer of the formula (1) and a second monomer of

the formula (2) in an organic solvent in the presence of an acid or alkaline

catalyst and water:



wherein,

 R_1 is H, C_{1-3} alkyl or C_{6-15} aryl;

each of X_1 , X_2 and X_3 , independently, is C_{1-3} alkyl, C_{1-10} alkoxy or halogen, provided that at least one of them is hydrolysable;

m is an integer from 0 to 10; and

p is an integer from 3 to 8; and

wherein,

 R_2 is H, C_{1-3} alkyl or C_{6-15} aryl;

 X_4 is C_{1-10} alkoxy;

 Y_1 is C_{1-3} alkyl or C_{1-10} alkoxy; and

n is an integer from 0 to 10.

18. (Original) The interlayer insulating film according to claim 17, wherein the porogen is selected from a group consisting of cyclodextrin, polycaprolactone, and derivatives thereof.

JTE/REG:jls

Docket No.: 3811-0130P

Docket No.: 3811-0130P

19. (Previously Presented) A semiconductor device containing an insulating film made from a siloxane-based resin prepared by hydrolyzing and polycondensing a first monomer of the formula (1) and a second monomer of the formula (2) in an organic solvent in the presence of an acid or alkaline catalyst and water:

$$\begin{array}{c|c}
R_1 \\
\hline
Si \\
CH_2(CH_2)_mSiX_1X_2X_3
\end{array}$$
(1)

wherein,

 R_1 is H, C_{1-3} alkyl or C_{6-15} aryl;

each of X_1 , X_2 and X_3 , independently, is C_{1-3} alkyl, C_{1-10} alkoxy or halogen, provided that at least one of them is hydrolysable;

m is an integer from 0 to 10; and

p is an integer from 3 to 8; and

wherein,

 R_2 is H, C_{1-3} alkyl or C_{6-15} aryl;

 X_4 is C_{1-10} alkoxy;

Application No. 10/695,777 Amendment dated August 9, 2005 After Final Office Action of May 9, 2005 Docket No.: 3811-0130P

 Y_1 is $C_{1\mbox{-}3}$ alkyl or $C_{1\mbox{-}10}$ alkoxy; and

n is an integer from 0 to 10.